

Polytec TC 406

Properties

Polytec TC 406 is a pasty, two component epoxy with curing at room temperature, used for thermal management in electronics, hybrid technology, sensor technology and power engineering.

Polytec TC 406 has a good thermal resistance as well an excellent thermal conductivity.

The application can be performed directly from the side-by-side cartridge with a static mixing nozzle, using a dispensing gun.



Processing

- The processing of two-component products from side-by-side cartridges is very simple.
- The cartridge is inserted into a suitable dispensing gun. The closing cap of the cartridge is then removed and replaced by an according static mixing nozzle.
- By activating the trigger of the dispensing gun, the two components are pressed out and automatically mixed in the static mixer.
- In order to prevent mixing errors, dispose the first half of the content in the mixing nozzel prior to application.
- Processing should be carried out rapidly after mixing the components; as an indication, the pot life can be used.
- When the pot life is exceeded, the mixing tube should be replaced with a new one.
- Close the cartridge with the cap after use.
- Surfaces should be clean, thus free of dirt, grease, oil, dust or process chemicals.
- Please take care of respective minimum curing temperature and time.
- For Safety information please refer to the respective Material Safety Data Sheet.

Polytec TC 406 Thermally Conductive Adhesive Technical Data



Polytec TC 406

Properties in uncured state	Method	Unit	Technical Data
Chemcical basis	-	-	Ероху
No. of components	-	-	2
Mixing ratio by weight	+	-	100:47
Mixing ratio by volume	-	÷	2:1
Pot life at 23°C	TM 702	min	30
Shelf life at 23°C	TM 701	months	12
Consistency	TM 101	-	Creamy paste
Density Mix	TM 201.2	g/cm³	1.8
Density A-Part	TM 201.2	g/cm³	1.9
Density B-Part	TM 201.2	g/cm³	1.7
Type of filler	-	-	Boron nitride
Max. particle size	-	μm	-
Viscosity Mix 84 s ⁻¹ at 23°C	TM 202.1	mPa∙s	180 000
Viscosity A-Part 84 s ⁻¹ at 23°C	TM 202.1	mPa∙s	-
Viscosity B-Part 84 s ⁻¹ at 23°C	TM 202.1	mPa∙s	-

Properties in cured* state	Method	Unit	Technical Data
Color	TM 101	-	white
Hardness (Shore D)	DIN EN ISO 868	-	85
Max. service temperature (continuous)	TM 302	°C	-55 / +150
Max. service temperature (short-term)	TM 302	°C	-55 / +240
Degradation temperature	TM 302	°C	300
Glass transition temperature (T_g)	TM 501	°C	65
Coefficient of thermal expansion (<t<sub>g)</t<sub>	ISO 11359-2	ppm	-
Coefficient of thermal expansion (>T _g)	ISO 11359-2	ppm	-
Thermal conductivity	TM 502	W/m·K	2.2 ±0.1
Specific volume resistivity	DIN EN ISO 3915	Ω ·cm	-
Young's modulus	TM 605	N/mm²	5000
Tensile strength	TM 605	N/mm²	27
Lap shear strength (Al/Al)	TM 604	N/mm²	14
Elongation at break	TM 605	%	3.5
Water absorption 24 h, 23°C	TM 301	%	-

^{*}The above data has been determined with samples cured at room temperature. Please notice, by varying the curing temperature these properties can be influenced to some extend.



Polytec TC 406

Curing*	Method	Unit	Technical Data
Minimum curing temperature		°C	15
Curing time at 23°C		h	24
Curing time at 80°C		min	60

Standard pack sizes:

50 mL 2K-cartridges Customized packaging

Please note:

The above listed information are typical data based on tests and are believed to be accurate. Polytec PT makes no warranties (expressed or implied) as to their accuracy. The above listed data do not constitute specifications. The processing (in particular the cure conditions) of the material, the process control and the variety of different applications at various customers are not under Polytec PT's control. Therefore Polytec PT will not be liable for concrete results in any specific application or in any connection with the use of this product. In particular the cure conditions do have a major effect on the properties of the cured material. Therefore it is highly recommended to keep the cure schedule – once established - under tight control. With the release of this data sheet all former data sheets will be null and void.

Subject to alteration.

Polytec PT GmbH
Polymere Technologien
Ettlinger Straße 30
76307 Karlsbad
Germany
Tel. +49 (0) 7243 604-4000
Fax +49 (0) 7243 604-4200
info@polytec-pt.de
http://www.polytec-pt.de

Polytec France S.A.S.
TECHNOSUD II
Bâtiment A
99, Rue Pierre Semard
92320 Châtillon - France
Phone. +33 (0)1 49 65 69 00
Fax +33 (0)1 57 19 59 60
info@polytec.fr
http://www.polytec-pt.com

Polytec South-East Asia Pte Ltd Blk 4010 Ang Mo Kio Ave 10 #06-06 Techplace I Singapore 569626 Tel. +65 6451 0886 Fax +65 6451 0822 info@polytec-sea.com http://www.polytec-pt.com

^{*}Curing temperatures refer to the temperature in the respective bond line. When choosing the respective curing conditions, the time needed to heat the substrate has to be considered. Depending on the type of heat source (convection oven, hot stamp, heating plate) the heat input may vary.